



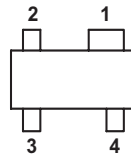
MOSMIC[®] for TV-Tuner Prestage with 5 V Supply Voltage

Comments

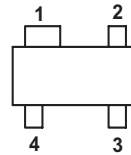
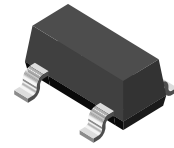
MOSMIC - MOS Monolithic Integrated Circuit

Features

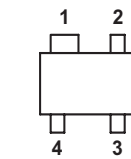
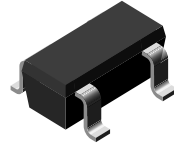
- Integrated gate protection diodes
- Low noise figure
- High gain
- Biasing network on chip
- Improved cross modulation at gain reduction
- High AGC-range
- SMD package
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC



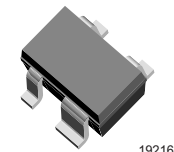
SOT-143



SOT-143R



SOT-343R



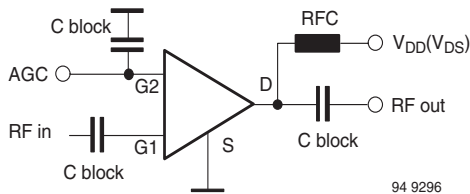
19216



Electrostatic sensitive device. Observe precautions for handling.

Applications

Low noise gain controlled input stages in UHF-and VHF- tuner with 5 V supply voltage.



94 9296

Mechanical Data

Typ: S595T

Case: SOT-143 Plastic case

Weight: approx. 8.0 mg

Pinning: 1 = Source, 2 = Drain, 3 = Gate 2, 4 = Gate 1

Typ: S595TR

Case: SOT-143R Plastic case

Weight: approx. 8.0 mg

Pinning: 1 = Source, 2 = Drain, 3 = Gate 2, 4 = Gate 1

Typ: S595TRW

Case: SOT-343R Plastic case

Weight: approx. 6.0 mg

Pinning: 1 = Source, 2 = Drain, 3 = Gate 2, 4 = Gate 1

Parts Table

Part	Marking	Package
S595T	595	SOT-143
S595TR	59R	SOT-143R
S595TRW	W59	SOT-343R

Absolute Maximum Ratings

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Drain - source voltage		V_{DS}	8	V
Drain current		I_D	30	mA
Gate 1/Gate 2 - source peak current		$\pm I_{G1/G2SM}$	10	mA
Gate 1/Gate 2 - source voltage		$\pm V_{G1/G2SM}$	6	V
Total power dissipation	$T_{amb} \leq 60\text{ }^{\circ}\text{C}$	P_{tot}	200	mW
Channel temperature		T_{Ch}	150	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	- 55 to + 150	$^{\circ}\text{C}$

Maximum Thermal Resistance

Parameter	Test condition	Symbol	Value	Unit
Channel ambient	1)	R_{thChA}	450	K/W

1) on glass fibre printed board (25 x 20 x 1.5) mm³ plated with 35 μm Cu

Electrical DC Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Gate 1 - source breakdown voltage	$\pm I_{G1S} = 10\text{ mA}, V_{G2S} = V_{DS} = 0$	$\pm V_{(BR)G1SS}$	7		10	V
Gate 2 - source breakdown voltage	$\pm I_{G2S} = 10\text{ mA}, V_{G1S} = V_{DS} = 0$	$\pm V_{(BR)G2SS}$	7		10	V
Gate 1 - source leakage current	$+ V_{G1S} = 5\text{ V}, V_{G2S} = V_{DS} = 0$	$+ I_{G1SS}$			50	μA
	$- V_{G1S} = 5\text{ V}, V_{G2S} = V_{DS} = 0$	$- I_{G1SS}$			100	μA
Gate 2 - source leakage current	$\pm V_{G2S} = 5\text{ V}, V_{G1S} = V_{DS} = 0$	$\pm I_{G2SS}$			20	nA
Drain current	$V_{DS} = 5\text{ V}, V_{G1S} = 0, V_{G2S} = 4\text{ V}$	I_{DSS}	50		500	μA
Self-biased operating current	$V_{DS} = 5\text{ V}, V_{G1S} = \text{nc}, V_{G2S} = 4\text{ V}$	I_{DSP}	9	13	18	mA
Gate 2 - source cut-off voltage	$V_{DS} = 5\text{ V}, V_{G1S} = \text{nc}, I_D = 20\text{ }\mu\text{A}$	$V_{G2S(OFF)}$		1.0		V

Caution for Gate 1 switch-off mode:

No external DC-voltage on Gate 1 in active mode!

Switch-off at Gate 1 with $V_{G1S} < 0.7\text{ V}$ is feasible.

Using open collector switching transistor (inside of PLL), insert 10 k Ω collector resistor.

Electrical AC Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

$V_{DS} = 5\text{ V}, V_{G2S} = 4\text{ V}, I_D = I_{DSP}, f = 1\text{ MHz}$

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Forward transadmittance		$ y_{21s} $	28	30	35	mS
Gate 1 input capacitance		C_{issg1}		2.3	2.7	pF
Feedback capacitance		C_{rss}		25		fF
Output capacitance		C_{oss}		1.1		pF
Power gain	$G_S = 2\text{ mS}, G_L = 0.5\text{ mS}, f = 200\text{ MHz}$	G_{ps}		28		dB
	$G_S = 3.3\text{ mS}, G_L = 1\text{ mS}, f = 800\text{ MHz}$	G_{ps}	17	20		dB



Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
AGC range	$V_{DS} = 5\text{ V}$, $V_{G2S} = 1\text{ to }4\text{ V}$, $f = 800\text{ MHz}$	ΔG_{ps}	45			dB
Noise figure	$G_S = 2\text{ mS}$, $G_L = 0.5\text{ mS}$, $f = 200\text{ MHz}$	F		1		dB
	$G_S = 3.3\text{ mS}$, $G_L = 1\text{ mS}$, $f = 800\text{ MHz}$	F		1.3		dB

Common Emitter S-Parameters

f/MHz	S11		S21		S12		S22	
	LOG MAG	ANG	LOG MAG	ANG	LOG MAG	ANG	LOG MAG	ANG
		deg		deg		deg		deg
50	-0.01	-4.6	9.61	174.3	-63.13	88.0	-0.08	-2.1
100	-0.03	-9.2	9.56	167.9	-56.88	85.3	-0.10	-4.3
150	-0.11	-13.8	9.44	161.3	-53.46	82.8	-0.14	-6.4
200	-0.19	-18.1	9.30	155.1	-51.38	80.7	-0.16	-8.6
250	-0.28	-22.6	9.15	148.4	-49.76	78.3	-0.22	-11.0
300	-0.40	-26.8	9.00	142.7	-48.70	77.3	-0.26	-12.9
350	-0.51	-31.1	8.79	136.8	-47.92	76.4	-0.30	-15.1
400	-0.64	-35.2	8.62	130.7	-47.45	76.2	-0.38	-17.1
450	-0.78	-39.3	8.35	125.3	-47.23	76.7	-0.43	-18.8
500	-0.93	-43.2	8.17	119.7	-47.10	78.4	-0.49	-20.6
550	-1.07	-47.1	7.94	114.2	-47.22	82.3	-0.55	-22.6
600	-1.22	-50.8	7.71	108.7	-46.92	88.6	-0.60	-24.6
650	-1.36	-54.4	7.50	104.1	-46.68	92.6	-0.66	-26.1
700	-1.49	-58.2	7.26	99.1	-46.47	98.8	-0.70	-27.9
750	-1.65	-61.5	7.08	94.1	-46.45	107.2	-0.73	-29.8
800	-1.79	-65.2	6.86	89.2	-45.89	116.7	-0.78	-31.7
850	-1.94	-68.6	6.68	84.5	-44.77	125.9	-0.80	-33.4
900	-2.04	-72.0	6.44	79.3	-43.51	133.0	-0.85	-35.4
950	-2.17	-75.3	6.27	74.4	-41.91	137.1	-0.87	-37.2
1000	-2.29	-78.7	6.09	70.4	-40.66	138.5	-0.89	-39.1
1050	-2.42	-82.2	5.93	65.8	-39.81	140.6	-0.90	-41.1
1100	-2.58	-85.2	5.67	61.1	-38.89	143.6	-0.92	-42.6
1150	-2.70	-88.4	5.55	56.1	-37.91	145.8	-0.93	-44.6
1200	-2.78	-91.6	5.41	51.8	-36.76	148.3	-0.94	-46.7
1250	-2.89	-94.8	5.38	47.1	-35.65	149.7	-0.93	-49.1
1300	-3.00	-97.7	5.17	42.0	-34.63	150.1	-0.92	-51.0

Typical Characteristics (T_{amb} = 25 °C unless otherwise specified)

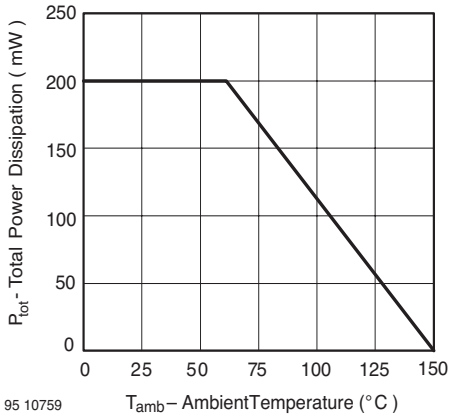


Figure 1. Total Power Dissipation vs. Ambient Temperature

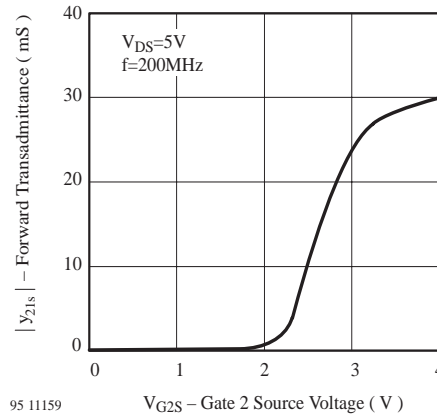


Figure 4. Forward Transadmittance vs. Gate 2 Source Voltage

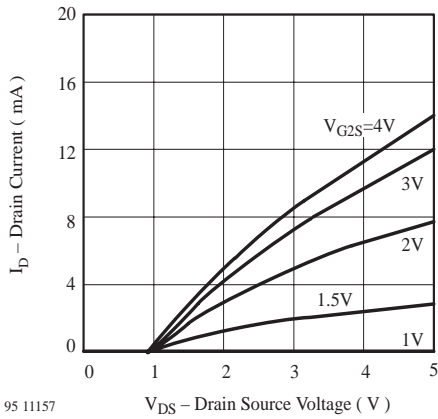


Figure 2. Drain Current vs. Drain Source Voltage

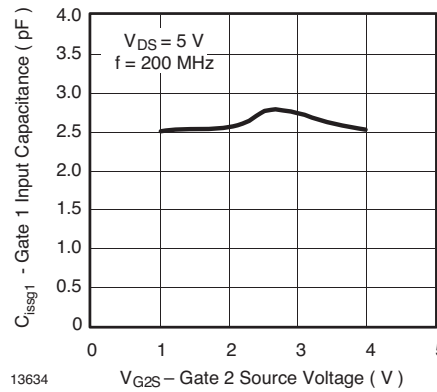


Figure 5. Gate 1 Input Capacitance vs. Gate 2 Source Voltage

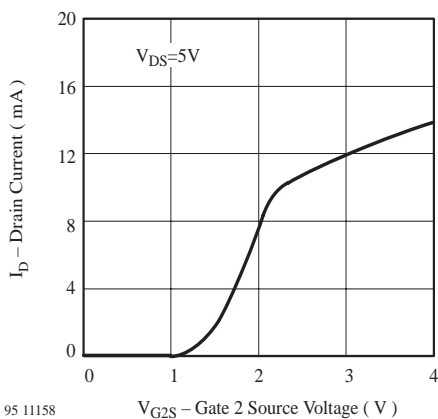


Figure 3. Drain Current vs. Gate 2 Source Voltage

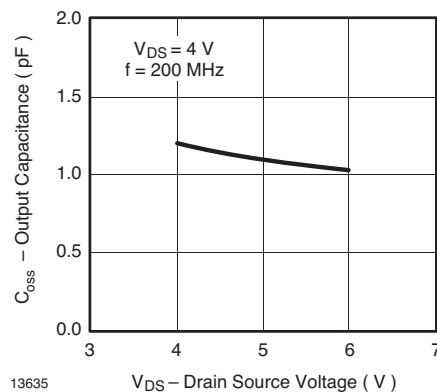


Figure 6. Output Capacitance vs. Drain Source Voltage

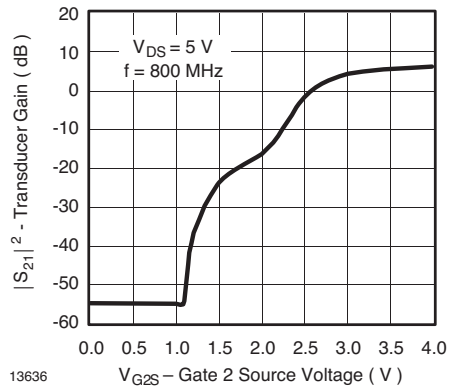


Figure 7. Transducer Gain vs. Gate 2 Source Voltage

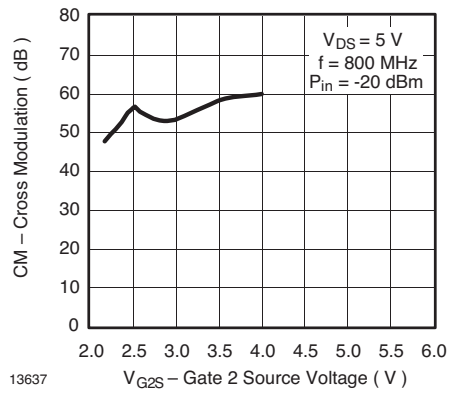


Figure 8. Cross Modulation vs. Gate 2 Source Voltage

S595T / S595TR / S595TRW



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$V_{DS} = 10\text{ V}$, $I_D = 10\text{ mA}$, $Z_0 = 50\ \Omega$

S_{11}

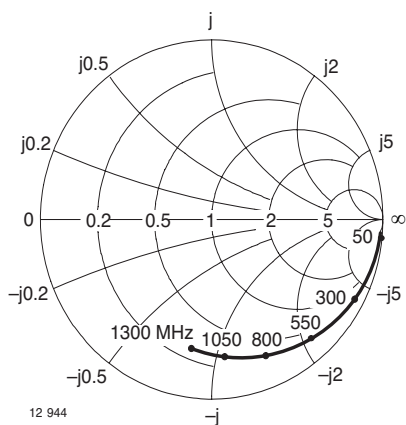


Figure 9. Input Reflection Coefficient

S_{12}

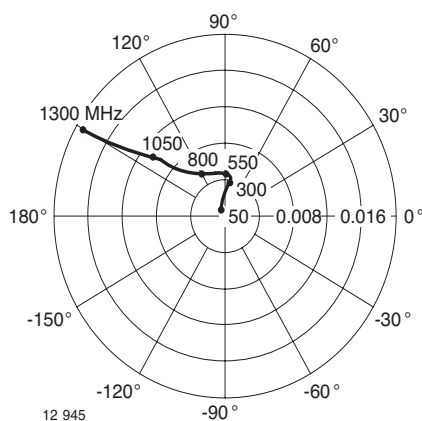


Figure 11. Reverse Transmission Coefficient

S_{21}

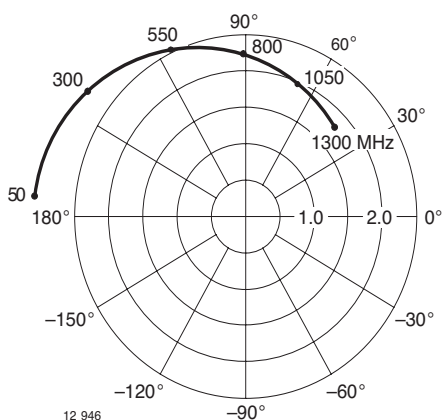


Figure 10. Forward Transmission Coefficient

S_{22}

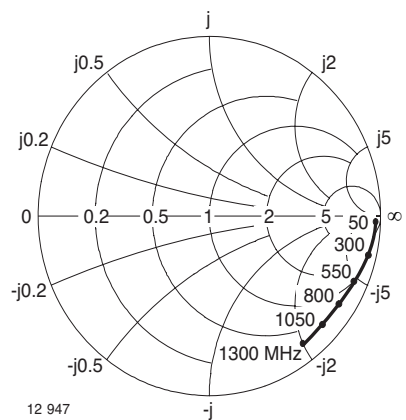
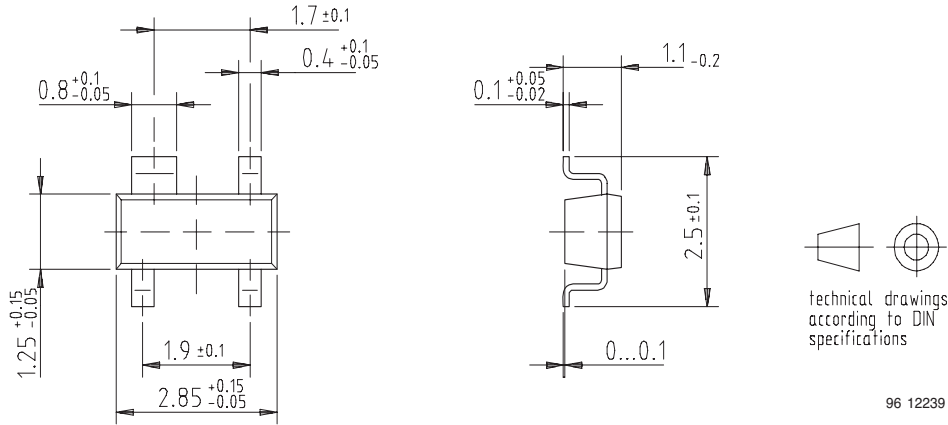
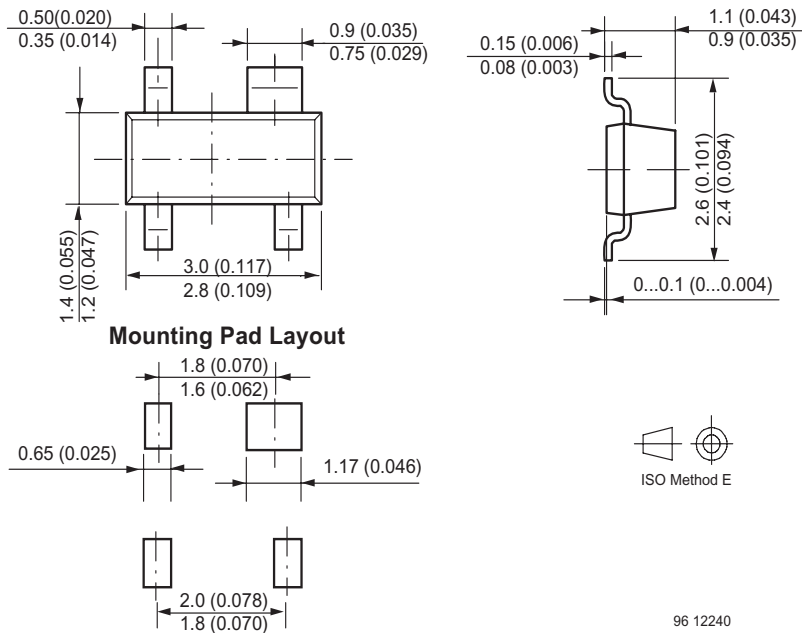


Figure 12. Output Reflection Coefficient

Package Dimensions in mm



Package Dimensions in mm

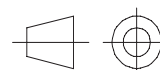
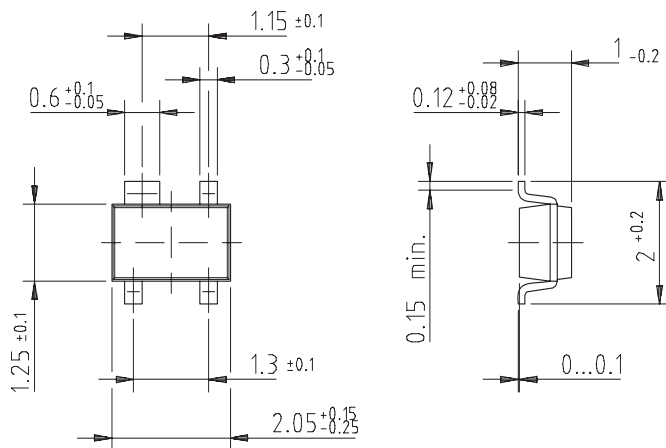


S595T / S595TR / S595TRW

Vishay Semiconductors



Package Dimensions in mm



technical drawings
according to DIN
specifications

96 12238



Ozone Depleting Substances Policy Statement

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1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

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